



CPC1008N Single-Pole, Normally Open 4-Pin SOP OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	100	V _P
Load Current	150	mA _{rms} / mA _{DC}
On-Resistance (max)	8	Ω

Features

- 1500V_{rms} Input/Output Isolation
 Small 4-Pin SOP Package
- Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Halogen-Free
- Tape & Reel Version Available
- Flammability Rating UL 94 V-0

Applications

- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security Systems
- Aerospace
- Industrial Controls
- Reed Relay Replacement

Description

CPC1008N is a miniature, low-voltage, low on-resistance, single-pole, normally open (1-Form-A) solid state relay in a 4-Pin SOP package. It uses IXYS Integrated Circuits Division's patented, optically coupled, OptoMOS architecture to provide 1500Vrms of input/output isolation.

Using IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging, the CPC1008N is one of the world's smallest relays. It is ideal for replacing larger, less-reliable reed and electromechanical relays.

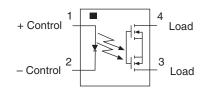
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate B 13 12 82667 003

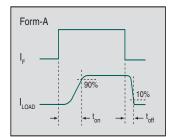
Ordering Information

Part #	Description
CPC1008N	4-Pin SOP (100/tube)
CPC1008NTR	4-Pin SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Open Devices





Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	100	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation	70	mW
Total Power Dissipation ¹	400	mW
Isolation Voltage, Input to Output (60 Seconds)	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements

¹ Derate linearly 3.33 mW / °C

Electrical Characteristics @ 25°C

Conditions	Symbol	Min	Тур	Max	Units
1				I	-
-	ΙL			150	mA _{rms} / mA _{DC}
t=10ms	I _{LPK}	-	-	±350	mA _P
I _L =150mA	R _{ON}	-	4.8	8	Ω
V _L =100V _P		-	-	1	μA
$\int Em \Lambda (10)/$	t _{on}	-	1	2	
$r_{\rm F}$ =5111A, $v_{\rm L}$ =10V	t _{off}	-	0.17	1	ms
I _F =0mA, V _L =50V, f=1MHz	C _{OUT}	-	6	-	pF
I _L =150mA	I _F	-	0.45	2	mA
-	l _F	0.2	-	-	mA
I _F =5mA	V _F	0.9	1.2	1.5	V
V _R =5V	I _R	-	-	10	μΑ
1				1	
V _{IO} =0V, f=1MHz	C _{IO}	-	1	-	pF
	$- \\ t=10ms \\ I_{L}=150mA \\ V_{L}=100V_{P} \\ I_{F}=5mA, V_{L}=10V \\ I_{F}=0mA, V_{L}=50V, f=1MHz \\ \\ I_{L}=150mA \\ - \\ I_{F}=5mA \\ V_{R}=5V \\ \end{bmatrix}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

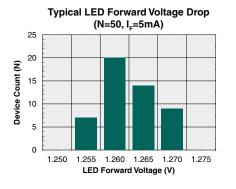
Load current derates intearry from 150mA @ 25°C to 120mA @ 85°C.
 ² Measurement taken within 1 second of on time.

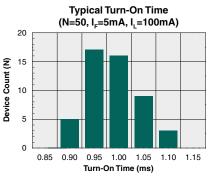
³ For high temperature operation (>60°C) a minimum LED drive current of 4mA is recommended.

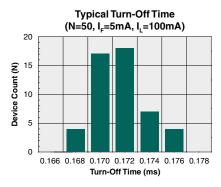


CPC1008N

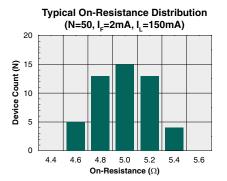
PERFORMANCE DATA*



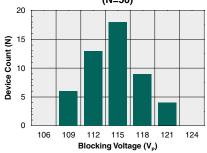


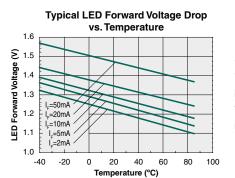


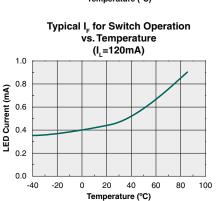
Typical I_F for Switch Operation (N=50, I_L=100mA)

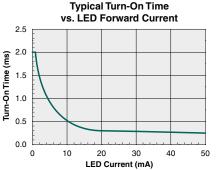


Typical Blocking Voltage Distribution (N=50)









 Typical Turn-Off Time vs. LED Forward Current

 0.25
 0.20

 0.15
 0.15

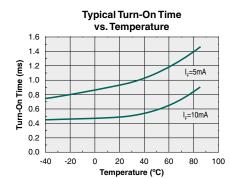
 0.10
 0.05

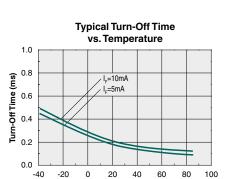
 0.00
 0.00

 0.010
 0.00

 0.00
 0.00

 0.00
 0.00





Temperature (°C)

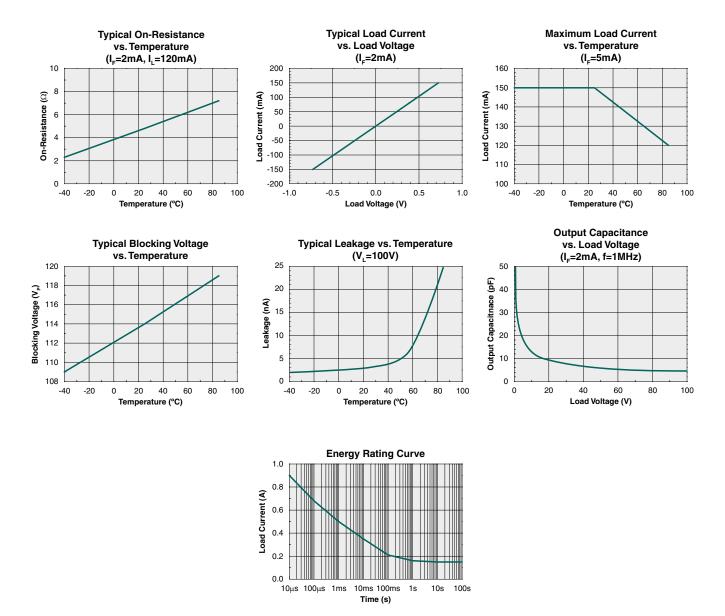
LED Current (mA)

*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.



CPC1008N

PERFORMANCE DATA*



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification		
CPC1008N	MSL 3		

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Soldering Profile

Provided in the table below is the Classification Temperature (T_c) of this product and the maximum dwell time the body temperature of this device may be (T_c - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

	Device	Classification Temperature (T _c)	Dwell Time (t _p)	Max Reflow Cycles
ſ	CPC1008N	260°C	30 seconds	3

Board Wash

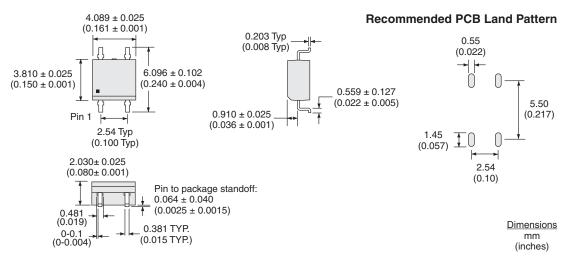
IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



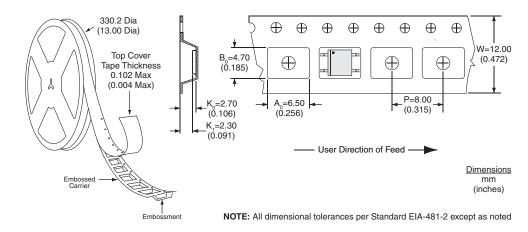


MECHANICAL DIMENSIONS

CPC1008N



CPC1008NTR Tape & Reel



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